

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Ligang Zhang et al.
Title: REDISTRIBUTION LAYER SHIELDING OF A CIRCUIT ELEMENT
Application No.: 10/814,816 Filed: March 31, 2004
Examiner: Not yet assigned Group Art Unit: Not yet assigned
Atty. Docket No.: 026-0041

April 30, 2004

Mail Stop Amendment
COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, VA 22313-1450

**INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. § 1.97**

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, the undersigned brings the patents, publications, applications or other information identified in the attached:

- ☒ Form(s) PTO-1449
☒ Other: List of Pending U.S. Patent Applications

to the Examiner's attention in the above-identified application. Citation of such information shall not be construed as:

1. an admission that the information necessarily is, or corresponds to, prior art with respect to the instant invention;
2. a representation that a search has been made, other than as described below; or
3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).


Pursuant to 1276 OG 55 (August 5, 2003), Information Disclosure Statements may be filed without copies of U.S. Patents and Published Applications in Patent Applications filed after June 30, 2003.

For each item of information listed that is not in the English language, the undersigned has provided a concise explanation of the relevance through (i) an English language abstract, (ii) an English language equivalent application, or (iii) if cited in a search report or other action by a foreign patent office in a counterpart foreign application, an English language version of the search report or action that indicates the degree of relevance found by the foreign office.

FEE AUTHORIZATION

- ☒ This Information Disclosure Statement is filed within three months of the filing date of a national application other than a continued prosecution application under § 1.53(d) or within three months of entry of the national stage as set forth in § 1.491 in an international application. Therefore, no fee is required.
- ☐ The undersigned believes that this Information Disclosure Statement is being filed before the mailing date of a first Office action on the merits or before the mailing date of a first Office action after the filing of a request for continued examination under § 1.114. Therefore, no fee is believed required.

If however, this Information Disclosure Statement is filed after the period specified in § 1.97(b), the undersigned hereby authorizes the Commissioner to charge the fee set forth in § 1.17(p) to Deposit Account No. 50-0631.

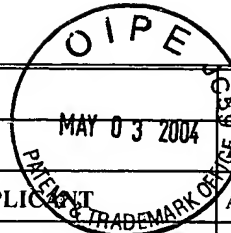
<u>CERTIFICATE OF MAILING OR TRANSMISSION</u>	
I hereby certify that, on the date shown below, this correspondence is being	
<input checked="" type="checkbox"/>	deposited with the US Postal Service with sufficient postage as first class mail, in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.
<input type="checkbox"/>	facsimile transmitted to the US Patent and Trademark Office.
 Nicole Teitler Cave	<u>4/30/04</u> Date

Respectfully submitted,



Nicole Teitler Cave, Reg. No. 54,021
Attorney for Applicant(s)
(512) 338-6315
(512) 338-6301 (fax)

EXPRESS MAIL LABEL: _____



U.S. Department of Commerce, Patent and Trademark Office

Attorney Docket No.: 026-0041

Application No.: 10/814,816

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

Applicant(s): Ligang Zhang et al.

(Use several sheets if necessary)

Filing Date: March 31, 2004

Group Art Unit: Not yet assigned

Date Submitted: April 30, 2004

U.S. Patent Documents

*Examiner Initial		Document Number	Date	Name
	AA	5,083,236	Jan. 21, 1992	Chason et al.
	AB	5,461,353	Oct. 24, 1995	Eberhardt
	AC	6,218,729	Apr. 17, 2001	Zavrel, Jr. et al.
	AD	6,362,525	Mar. 26, 2002	Rahim
	AE	6,389,691	May 21, 2002	Rinne et al.
	AG	6,486,534	Nov. 26, 2002	Sridharan et al.
	AH			
	AI			
	AJ			
	AK			

Foreign Patent Documents

					Translation	
		Document	Date	Country	Yes	No
	AL	0 675 539 A2	Oct. 4, 1995	Europe		
	AM	WO 02/067326 A2	Aug. 29, 2002	PCT		
	AN					
	AP					

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

	AR	"Unitive - CSP On the Edge", Unitive Inc. 2003 (from website - http://www.unitive.com/cspedge/index.cfm), 2 pages.
	AS	"Unitive Design Guidelines", www.unitive.com , 2001, pp. 1-18.
	AT	

Examiner

Date Considered

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.



Attorney Docket No.: 026-0041
Application No.: 10/814,816
Applicant(s): Ligang Zhang et al.
Filing Date: March 31, 2004
Group Art Unit: Not yet assigned
Date Submitted: April 30, 2004

LIST OF PENDING U.S. PATENT APPLICATIONS

The following pending U.S. patent applications are listed for consideration by the Examiner.

- 1) No. 10/463,961 entitled "INTEGRATED CIRCUIT PACKAGE CONFIGURATION INCORPORATING SHIELDED CIRCUIT ELEMENT STRUCTURE", filed October 15, 2002, Derrick C. Wei et al., inventors.

Applicant(s) are providing a separate list of pending applications, pursuant to MPEP § 609(D), to avoid publication of the application numbers on any patent that issues from the above-identified application. Applicant(s) request that the Examiner indicate consideration of the pending applications listed above in accordance with MPEP 609(C)(2) and return a copy of this page with the next communication.